SiSS4402DN

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Vishay Siliconix

RoHS

COMPLIANT

FREE

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PowerPAK® 1212-8S D 8 G Top View Bottom View

PRODUCT SUMMARY V_{DS} (V) 40 $R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V 0.0022 $R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V 0.0032 21.5 Q_q typ. (nC) I_D (A) a 128 Configuration Single

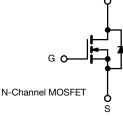
FEATURES

N-Channel 40 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- \bullet Very low Q_g and Q_{oss} reduce power loss and improve efficiency
- HALOGEN • Optimized Q_g, Q_{gd}, and Q_{gd}/Q_{gs} ratio reduces switching related power loss
- 100 % R_a and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- Synchronous buck converter
- High power density DC/DC
- Load switching



ORDERING INFORMATION	
Package	PowerPAK 1212-8S
Lead (Pb)-free and halogen-free	SiSS4402DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	40	V	
Gate-source voltage		V _{GS}	+20 / -16	v	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		128		
	T _C = 70 °C	1.	103		
	T _A = 25 °C	I _D	35.5 ^{b, c}		
	T _A = 70 °C	1	28 ^{b, c}	A	
Pulsed drain current (t = 100 µs)		I _{DM}	300	A	
Continuous source-drain diode current	T _C = 25 °C		59.8		
	T _A = 25 °C	I _S	4.5 ^{b, c}		
Single pulse avalanche current L = 0.1 mH		I _{AS}	25		
Single pulse avalanche energy		E _{AS}	31.25	mJ	
Maximum power dissipation	T _C = 25 °C		65.7		
	T _C = 70 °C		42	w	
	T _A = 25 °C	P _D	5 ^{b, c}	vv	
	T _A = 70 °C	1	3.2 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		
Soldering recommendations (peak temperature) ^c			260	U U	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b	t ≤ 10 s	R _{thJA}	20	25	°C/W		
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.5	1.9	0/00		

Notes

a. Based on $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

t = 10 s c.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

f. Maximum under steady state conditions is 63 °C/W

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	· · · ·		<u> </u>				
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	25	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-5.2	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	2.5	V	
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = +20, -16 V	-	-	± 100	nA	
Zero gate voltage drain current		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	— uA	
	IDSS	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	10		
D · · · · · · · · ·		V _{GS} = 10 V, I _D = 15 A	-	0.0018	0.0022	- Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	0.0024	0.0032		
Forward transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 15 A	-	98	-	S	
Dynamic ^b			•		•		
Input capacitance	C _{iss}		-	3850	-	pF	
Output capacitance	Coss	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz	-	655	-		
Reverse transfer capacitance	C _{rss}		-	75	-		
		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	46.7	70	nC	
Total gate charge	Qg		-	21.5	32		
Gate-source charge	Q _{qs}	V_{DS} = 20 V, V_{GS} = 4.5 V, I_{D} = 10 A	-	9.3	-		
Gate-drain charge	Q _{qd}		-	4	-		
Output charge	Q _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	24.5	-		
Gate resistance	Rg	f = 1 MHz	0.5	1.1	1.8	Ω	
Turn-on delay time	t _{d(on)}		-	15	30	-	
Rise time	tr	$\label{eq:VDD} \begin{array}{l} V_{DD} = 20 \ V, \ R_L = 1 \ \Omega \\ I_D \cong 10 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$	-	6	12		
Turn-off delay time	t _{d(off)}		-	30	60		
Fall time	t _f		-	6	12		
Turn-on delay time	t _{d(on)}		-	26	52	ns	
Rise time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 1 \Omega$	-	63	126		
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	33	66		
Fall time	t _f		-	10	20		
Drain-Source Body Diode Characteristic	1 1						
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	59.8		
Pulse diode forward current ($t_p = 100 \ \mu s$)	I _{SM}	-		-	300	A	
Body diode voltage	V _{SD}	I _S = 5 A	-	0.73	1.1	V	
Body diode reverse recovery time	t _{rr}		-	29	58	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	23	46	nC	
Reverse recovery fall time	t _a	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	15	-	ns	
Reverse recovery rise time	t _b		_	14	-		

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

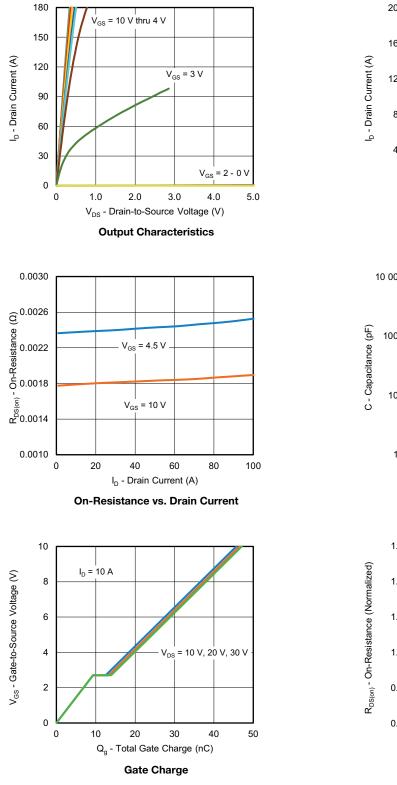
b. Guaranteed by design, not subject to production testing

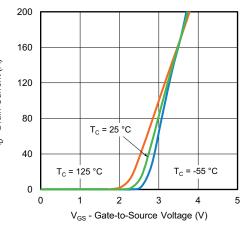
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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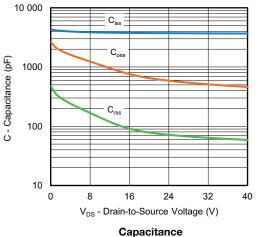


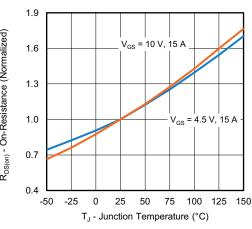
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Transfer Characteristics





On-Resistance vs. Junction Temperature

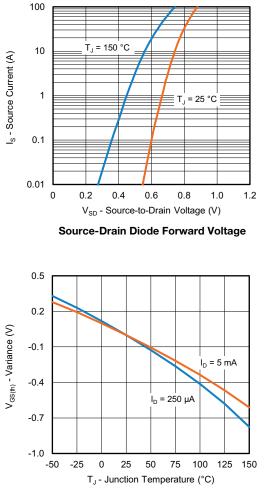
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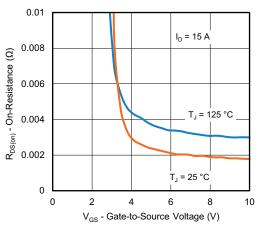
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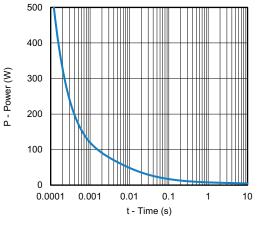
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



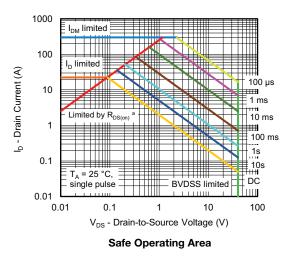
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



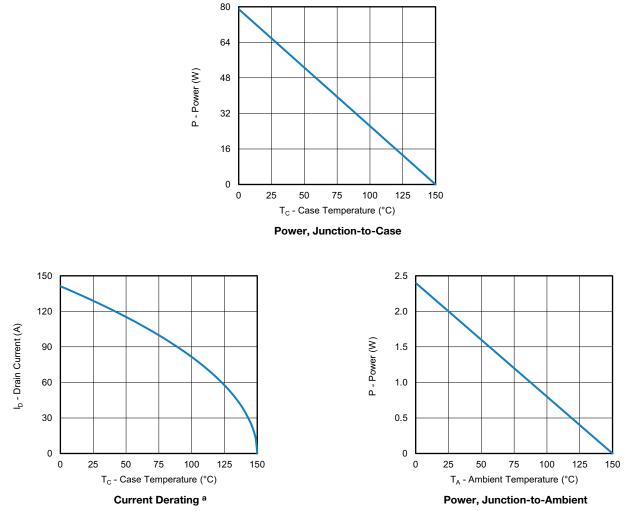
Note

a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

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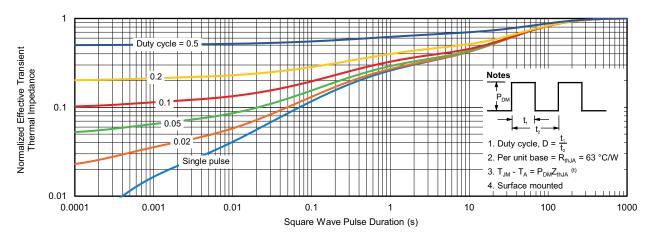


Note

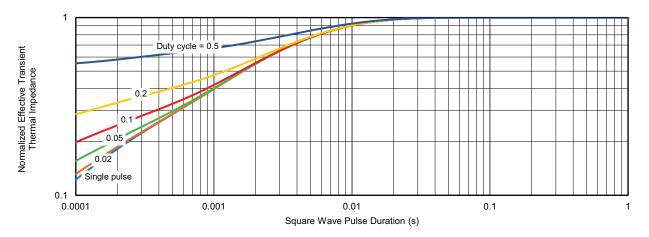
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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